7829

• PAIDC

QUERY CONTROL FORM			RTIS U	SE ONLY
Application No. 10 005,689	Prepared by	_ <i>N</i> .H.	Tracking Number	05884744
Examiner-GAU Zarnela - 2829	Date	1-29-04	Week Date	01/05/04
	No. of queries	1	IFW	

JACKET						
a. Serial No.	f. Foreign Priority	k. Print Claim(s)	p. PTO-1449			
b. Applicant(s)	g. Disclaimer	I. Print Fig.	q. PTOL-85b			
c. Continuing Data	h. Microfiche Appendix	m. Searched Column	r. Abstract			
d. PCT	i. Title	n. PTO-270/328	s. Sheets/Figs			
e. Domestic Priority	j. Claims Allowed	o. PTO-892	t. Other			

SPECIFICATION	MESSAGE
a. Page Missing	PTO-1449: Please Pither initial or line
b. Text Continuity	PTO-1449: Please either initial or line. Through citations. Copy provided for reference.
c. Holes through Data	
d. Other Missing Text	
e. Illegible Text	
f. Duplicate Text	
g. Brief Description	
h. Sequence Listing	
i. Appendix	
j. Amendments	
k. Other	
CLAIMS	
a. Claim(s) Missing	
b. Improper Dependency	Hankyon
c. Duplicate Numbers	٥
d. Incorrect Numbering	initials \mathcal{N}, \mathcal{H}
e. Index Disagrees	RESPONSE
f. Punctuation	
g. Amendments	
h. Bracketing	
i. Missing Text	
j. Duplicate Text	
k. Other	
	initials

INFORMATION DISCLOSURE CITATION (37 CFR 1.97)

Application Number Filing Date First Named Inventor Group Art Unit

Rutten

Examiner Name Attorney Docket US 018180

U.S. PATENT DOCUMENTS							
Examiner's Initials	Cite No.	Patent Number	Date	Name	Class	Sub- Class	Filing Date, If Approp.
	AA	6,075,373	13 June 2000	Iino			
	AB	6,169,410 B1	2 January 2001	Grace et al.			L
	AC	(copending application) "PRECONDITIONED INTEGRATED CIRCUIT FOR INTEGRATED CIRCUIT TESTING"		Rutten			(concurrent)
	AD						
	AE						<u> </u>
	AF					L	
	AG		<u> </u>	<u> </u>			ļ
	AH					<u> </u>	<u> </u>

FOREIGN PATENT DOCUMENTS								
Examiner's Ci		Patent Number	Date	Country	Class	Sub-	Translation	
Initials	No.					Class	Yes	No
	AI	EP 0 755 071 A2	18 July 1996	Europe			L	
	AJ							
	AK				L		1	<u>↓</u>
	AL							
	AM						<u> </u>	

Examiner's Initials	Cite No.	Other (Include Author, Title, Date, Pertinent Pages, Etc.)
	AN	"Introducing WOW Technology", http://www.formfactor.com/about/wow/wow_pg2.html
	AO	"Introducing WOW Technology", http://www.formfactor.com/about/wow/wow_pg5.html
	AP	"Focus on FormFactor", THE FINAL TEST REPORT, Vol. 12, No. 09, September 2001, Ikonix Corp. P.O. Box 1938, Lafayette, CA 94549-1938
	AQ	"Flip-Chip Bonding on 6-um Pitch using Thin-Film Microspring Technology", Donald L. Smith et at., Xerox Palo Alto Research Center, Proceedings, 48th Electronic Components and Technology Conference, IEEE, May 1998.
	AR	

Examiner	Date Considered
Examiner: Initial if reference considered, whether or not citation is in confor Draw line through citation if not in conformance and not considered next communication to the Applicant.	mance with MPEP 609; . Include a copy of this form with